Structural and optoelectrical properties of Nb-TiO₂ films fabricated by low-energy magnetron sputtering and post-annealing

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Keywords: Nb-doped TiO₂ (NTO) films have potential to replace indium tin oxide (ITO) as transparent conducting material. However, costly substrates with a specific orientation such as sapphire must be used to avoid formation of the rutile phase and to obtain transparent and conductive NTO films. Furthermore, scaling up is difficult thus hampering commercialization. Herein, in order to control the crystal orientation of TiO₂, two-step preparation is described. An amorphous NTO film is first prepared on the economical soda-lime glass substrate by low-energy magnetron sputtering and the sample is annealed in Ar with 5 at% H₂ at 400 °C to crystallize the amorphous structure into anatase (101) and anatase (004). The morphology, structure, and optoelectrical properties of the NTO films and relationship with film thickness are studied. The resistivity decreases to 8.1 × 10⁻⁵ Ωcm for a thickness of 320 nm and the average transmittance in the visible region increases monotonically to 73% as the thickness is reduced from 400 nm to 280 nm. The good conductivity and transmittance suggest potential application to smart windows and solar cells.

1. Introduction

Transparent conductive oxides (TCOs) are widely used as transparent electrodes in optoelectronic devices such as flat-panel displays [1], solar cells [2], smart windows and light-emitting diodes [3, 4]. Sn-doped In₂O₃ (ITO) is the most extensively used TCO due to its low re-abundant and nontoxic elements have aroused interest [8]. Nb-doped TiO₂ (NTO) is attractive due to the high conductivity and transparent properties [9]. Recently, NTO films prepared by pulsed laser deposition (PLD) [10], sputter deposition, and the sol-gel method [11–13] have been reported. Furubayashi et al. [10] found that pure anatase NTO epitaxial films prepared on single-crystal SrTiO₃ (100) substrates by PLD exhibited small resistivity of 3 × 10⁻⁴ Ωcm and excellent transmittance of > 90% in the visible region. However, a substrate with a specific orientation such as SrTiO₃ (100) must be used to avoid formation of the rutile phase and so large-scale production is difficult. Furthermore, when a glass substrate is used to deposit conductive NTO films by PLD, a resistivity on the order of 10⁻⁴ Ωcm can be obtained under the optimal conditions but the transmittance is only ~60% [12], which is not good enough for many applications. Sputtering has also been used to deposit NTO films on a large substrate with high throughput [13] and in order to avoid forming the rutile phase and improve the transparent property, a two-step process in which an amorphous NTO films is fabricated by magnetron sputtering and then crystallization occurs during annealing in H₂, vacuum, or N₂ [14]. However, the compromise between conductivity and transmittance is not well understood [15, 16]. It has been shown that the thickness of the NTO films (mostly < 200 nm for high transmittance) is positively related to the conductivity [17] but thicker TCO films are required in some applications such as CIGS and CdTe thin-film solar cells [18–20].

In this work, NTO films with different thicknesses are fabricated on the soda-lime glass substrate by a two-step process including low-energy magnetron sputtering and post-annealing in order to restrain the formation of poor optoelectrical rutile. The relationship between the structural, morphological, optical and electrical properties and film thickness is investigated in order to improve both the electrical conductivity and optical transparence.

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2. Experimental details

The NTO films were prepared in a vacuum chamber with a diameter of 60 cm and height of 50 cm. Before loading into the chamber, the soda-lime glass substrates were ultrasonically cleaned in ethanol and acetone for 30 min at room temperature (RT). A NTO target (95 at% TiO₂ and 5 at% Nb) 60 mm in diameter and 6 mm thick was mounted in the magnetron sputtering source. The soda-lime glass substrates were placed at a distance of 18 cm from the NTO target. After the chamber was evacuated to a base pressure of 8 × 10⁻⁴ Pa, the Ar gas (99.99% pure) flow rate was maintained at 8 sccm to keep the working pressure at 0.3 Pa. The NTO films were deposited on the substrates by direct-current magnetron sputtering (DCMS) at a current of 0.1 A and voltage of 370 V. The thickness of the NTO films was controlled by the sputtering time. After deposition, the samples underwent two-step annealing in Ar gas with 5 at% H₂. In the first step, the annealing temperature rose from room temperature to 250 °C at a heating rate of 10 °C per minute and the temperature was maintained for 0.5 h. In the second step, the annealing temperature was raised to 400 °C using the same heating rate and kept for 2 h. The samples were cooled inside the furnace to room temperature.

The crystalline structure was determined by X-ray diffraction (XRD, Bruker D8 Advance) in the continuous scanning mode using Cu Kα radiation. The coating thickness was measured by scanning electron microscopy (SEM, ZEISS SUPRA® 55). The electrical properties were characterized on a Hall Effect System (Ecopia, HMS3000) and the chemical composition determined by X-ray photoelectron spectroscopy (XPS, ESCALAB 250X, Thermo Fisher, UK). The binding energy was characterized on a Hall E® instrument. All the peeling-off areas are below 5% of the total areas revealing excellent adhesion (Level 4B, ASTM D3359).

Fig. 1 shows the cross-sectional SEM images revealing that the thicknesses of the NTO films are 280 nm, 320 nm, 360 nm, and 400 nm as the sputtering time is increased from 140 min to 200 min with a depositing rate of 2 nm/min. The cross-sectional SEM images of all samples show flat structure without appearance of obvious grain boundaries indicating some amorphous structures may be created by the low-energy deposition at a small sputtering current [21]. No apparent defects can be observed at the interfaces. The adhesion strength between the NTO films and glass substrates are measured by the adhesion cross cut test with a case size of 1 × 1 mm and shown in the inserts. All the peeling-off areas are below 5% of the total areas revealing excellent adhesion (Level 4B, ASTM D3359).

Fig. 2 shows the structural evolution of the NTO films before and after post-annealing monitored by XRD. No apparent peaks can be observed from the films indicating an amorphous structure consistent with SEM as shown in Fig. 2(a). After post-annealing, the NTO films crystallize and two obvious peaks at 25.6° and 38.2° corresponding to the anatase (101) and anatase (004) orientations, respectively, emerge, as shown in Fig. 2(b). The intensity of the anatase (101) peak is almost constant while that of anatase (004) increases with thickness up to 320 nm. The largest intensity is observed when the thickness is 320 nm, indicating good crystallization. Although the rutile (210) peak at 44.8° and rutile (211) peak at 54.3° are observed from all samples after annealing at 400 °C [22, 23], the peak intensity is quite low. All in all, the results show that the anatase NTO films can be produced on a glass substrate by the two-step process involving low-energy magnetron sputtering and post-annealing.

TEMs of the different samples are performed and the results are shown in Fig. 3. The grains with the two preferred orientations, anatase (101) and (004), are marked by yellow and red lines, respectively. The results reveal that the grain sizes are about 5–20 nm and are declining with the decreasing thickness. This phenomenon is consist with many previous reports and demonstrated by the effect of grain grooves (the thermal pitting of a surface in the vicinity of a grain boundary vertex) on grain size [24–29].

The surface composition and chemical states are determined by XPS and the results are shown in Fig. 4. Nb, Ti and O are detected as shown in Table 1. With the increase of the NTO thickness, the Nb and O concentrations increase from 2.56 at% to 2.74 at% and from 61.13 at% to 61.76 at%, respectively, whereas the Ti concentration decrease from 36.31 at% to 35.51 at%. The composition variation of Nb and Ti may be influenced by sputtering threshold energy and deposition temperature increase with the film thickness [30, 31]. The Nb peak in Fig. 4(a) is composed of two peaks at binding energies of 207 eV and 204 eV corresponding to Nb⁵⁺ and Nb²⁺, respectively. The results suggest successful Nb incorporation into the TiO₂ lattice as a result of the larger electronegativity of Nb (1.60) than that of Ti (1.54) [32], large amount of oxygen vacancy, and reductive Nb⁵⁺ produced during annealing in the oxygen-free atmosphere.

Fig. 5 shows the Hall measurement results of the NTO films for different thicknesses. The resistivity of NTO films is related to the carrier concentration and Hall mobility. The carrier concentration increases from 1.0 × 10²¹ cm⁻³ to 1.4 × 10²¹ cm⁻³ monotonically with thickness, which is closely related to Nb content. The Hall mobility increases from 4.8 cm²/Vs to 7.4 cm²/Vs initially due to the increase of grain size and Nb content [14, 32] but decreases when the film thickness is larger than 320 nm. The decrease of Hall mobility is mainly because of the increasing combination of electrons and holes accompanying with the increasing of oxygen vacancies [33–35]. Due to the high Hall mobility, the smallest resistivity of 8.1 × 10⁻⁴ Ω·cm is achieved for the 320 nm thick NTO film.

The optical transmittance performance of the NTO films is important. Fig. 6 shows the optical transmittance and absorption in the visible range (320–780 nm) of the NTO films with different thicknesses and the average values are given in the insets. Although these NTO films are thicker than those reported before, the optical transmittance is still very large and the average transmittance in the visible region (400–760 nm) increases from 400 nm to 280 nm. Considering both the electrical and optical properties, the NTO film with a thickness of 320 nm has the best TCO characteristics. Obviously, the thickness increases the path for light absorption reducing the transmittance [17]. Besides, the anatase-dominated orientation in the NTO films results in good conductivity and transmittance [23]. The optical absorption of the NTO films show an opposite evolution with film thicknesses, but the largest average absorption in the visible region (400–760 nm) is only 0.19% when the film thickness is 400 nm. It has been shown that the reflection contributes to loss of transmittance because of the large difference in the refractive indexes between NTO and air [23, 36].

4. Conclusion

NTO films are fabricated on a soda-lime glass substrate by a two-step process involving low-energy magnetron sputtering and post-annealing. The anatase (101) and (004) polycrystalline NTO films are obtained and the morphology, composition, as well as optical and electrical properties are determined from films with different thicknesses. Owing to the larger grain size and Nb content in a thicker film, the carrier concentration and Hall mobility increase initially but the Hall mobility decreases as a result of the increasing combination of electrons and holes accompanying with the increasing of oxygen vacancies. The smallest resistance of 8.1 × 10⁻⁴ Ω·cm is achieved from the film with a thickness of 320 nm. Although the dominant anatase phase improves the transmittance in the visible range significantly, the best average transmittance is 73% due to reflection. Nonetheless, our results indicate that the polycrystalline anatase-dominant NTO films...
Fig. 1. Cross-sectional SEM images and the surface morphologies after cross cut test of the as-deposited NTO films deposited for (a) 200 min, (b) 180 min, (c) 160 min, and (d) 140 min; (e) film thickness.

Fig. 2. XRD patterns of the NTO films produced on the glass substrate: (a) As-deposited and (b) annealed.
have large potential as TCO materials but introduction of an antireflective film may be needed for further improvement.

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Fig. 6. (a) Optical transmittance and (b) optical absorption as a function of wavelength in the range of 320–780 nm obtained from the NTO films with different thicknesses. The insets in (a) and (b) show the average transmittance and average absorption in the visible region (400–760 nm).

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